

SiC Schottky Barrier Diode

V_R	650V
I _F	10A
Q_{C}	24nC

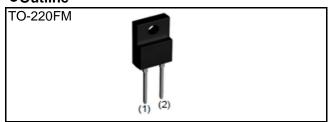
● Features

- 1) Shorter recovery time
- 2) Reduced temperature dependence
- 3) High-speed switching possible
- 4) High surge current capability

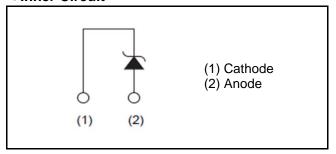
Construction

Silicon carbide epitaxial planar type

●Outline



●Inner Circuit



Packaging Specifications

	Packaging	Tube
	Reel size (mm)	-
Typo	Tape width (mm)	-
Туре	Basic ordering unit (pcs)	50
	Packing code	С
	Marking	SCS310AM

● Absolute Maximum Ratings (T_i = 25°C)

Parameter		Symbol	Value	Unit
Reverse voltage (re	epetitive peak)	V_{RM}	650	V
Reverse voltage (D	C)	V_R	650	V
Continuous forward	I current (T _c =95°C)	I _F	10	А
Surge non-	PW=10ms sinusoidal, T _j =25°C		82	А
repetitive forward	PW=10ms sinusoidal, T _j =150°C	I_{FSM}	69	A
current	PW=10μs square, T _j =25°C		300	А
Repetitive peak forward current		I _{FRM}	30 ^{*1}	А
1≦PW≦10ms, T _j =25°C		.∫ i²dt	33	A ² s
i ² t value 1≦PW≦10ms, T _j =150°C		J I-at	23	A ² s
Total power disspation		P_{D}	34 *²	W
Junction temperature		Tj	175	°C
Range of storage temperature		T_{stg}	-55 to +175	°C

^{*1} T_c=100°C, T_i=150°C, Duty cycle=10% *2 T_c=25°C

●Electrical characteristics (T_j = 25°C)

Parameter Symbol Conditions	Cumbal	Conditions	Values			Unit
	Min.	Тур.	Max.			
DC blocking voltage	V_{DC}	I _R =50μA	650	-	-	V
	V _F	I _F =10A,T _j =25°C	-	1.35	1.50	V
Forward voltage		I _F =10A,T _j =150°C	-	1.44	1.71	V
		I _F =10A,T _j =175°C	-	1.50	-	V
Reverse current	I _R	V _R =650V,T _j =25°C	-	0.03	50	μΑ
		V _R =650V,T _j =150°C	-	2	200	μΑ
		V _R =650V,T _j =175°C	-	6	-	μΑ
Total capacitance	С	V _R =1V,f=1MHz	-	500	-	pF
		V _R =650V,f=1MHz	-	46	-	pF
Total capacitive charge	Q_{C}	V _R =400V,di/dt=350A/μs	-	24	-	nC
Switching time	t _C	V _R =400V,di/dt=350A/μs	-	15	-	ns
Non-repetetive Avaranche Energy	E _{ava}	L=1mH	-	130	-	mJ

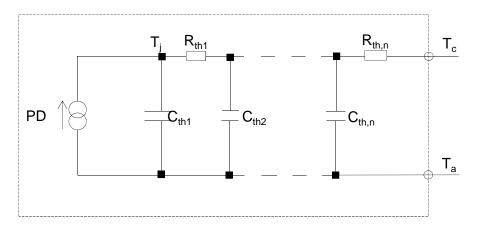
●Thermal characteristics

Parameter	Symbol	Conditions	Values			Unit
			Min.	Тур.	Max.	Offic
Thermal resistance	R _{th(j-c)}	-	-	3.6	4.3	°C/W

●Typical Transient Thermal Characteristics

Symbol	Value	Unit
R _{th1}	1.94E-01	
R _{th2}	1.19E+00	K/W
R _{th3}	2.24E+00	

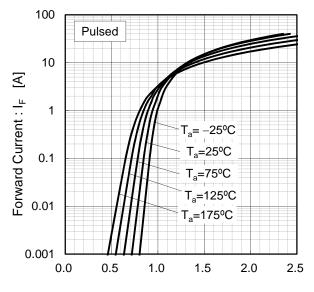
Symbol	Value	Unit
C _{th1}	4.93E-04	
C _{th2}	2.71E-03	Ws/K
C _{th3}	3.83E-01	



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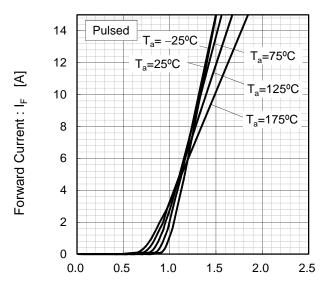
•Electrical characteristic curves

Fig.1 V_F - I_F Characteristics



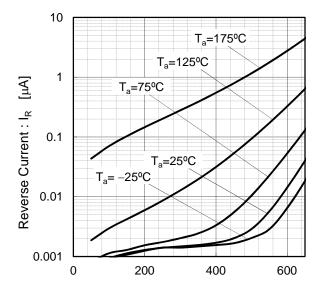
Forward Voltage : V_F [V]

Fig.2 V_F - I_F Characteristics



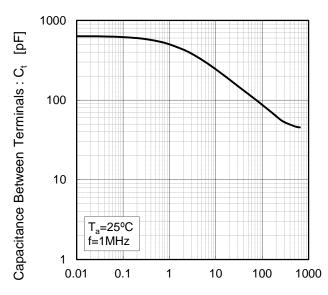
Forward Voltage : V_F [V]

Fig.3 V_R - I_R Characteristics



Reverse Voltage : V_R [V]

Fig.4 V_R-C_t Characteristics



Reverse Voltage : V_R [V]

•Electrical characteristic curves

Fig.5 Typical Transient Thermal Resistance vs. Pulse Width

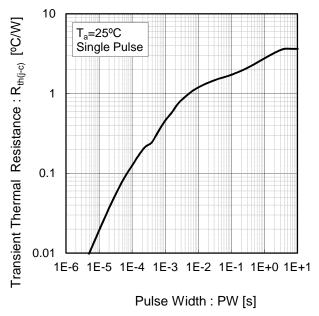
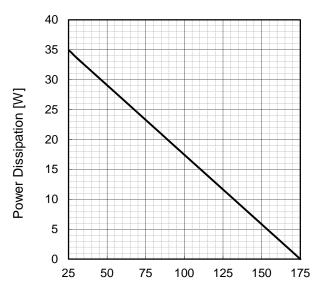
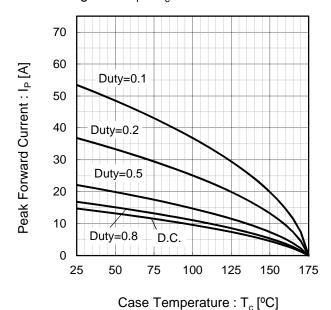


Fig.6 Power Dissipation



Case Temperature : T_c [°C]

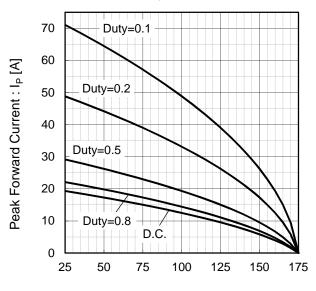
Fig.7*3 Maximum peak forward current derating curve I_P - T_c



*3 Based on max Vf, max $R_{\rm th(j-c)}$ Valid for switching of above 10kHz,

excluding D.C. curve.

Fig.8*4 Typical peak forward current derating curve I_P - T_c (Not guaranteed)

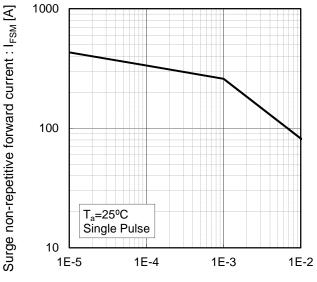


Case Temperature : T_c [°C]

*4 Based on typ Vf, typ R_{th(j-c)} Typical value, not guaranteed Valid for switching of above 10kHz, excluding D.C. curve

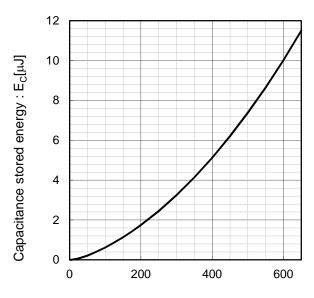
•Electrical characteristic curves

Fig.9 Surge non-repetitive forward current vs. Pulse width (Sinusoidal waveform)



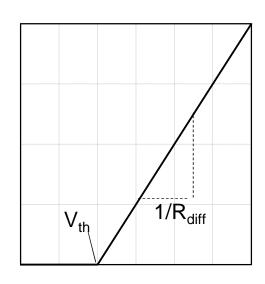
Pulse Width: PW [s]

Fig.10 Typical capacitance store energy



Reverse Voltage: V_R [V]

Fig.11 Equivalent forward current curve



Forward Voltage : V_F

$$V_F = V_{th} + R_{diff} I_F$$

$$V_{th} (T_j) = a_0 + a_1 T_j$$

 $R_{diff} (T_j) = b_0 + b_1 T_j + b_2 T_j^2$

Symbol	Typical Value	Unit
a_0	9.66E-01	V
a ₁	- 1.10E-03	V/°C
b_0	3.52E-02	Ω
b ₁	7.46E-05	Ω/°C
b ₂	7.68E-07	Ω /°C ²

$$T_i \text{ in } {}^{\circ}\text{C}; -55 {}^{\circ}\text{C} < T_i < 175 {}^{\circ}\text{C}; I_F < 20\text{A}$$

Forward Current: IF

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